

## Features

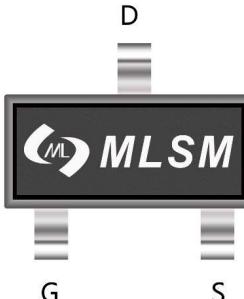
- Trench Power LV MOSFET technology
- High Power and current handing capability

## Product Summary

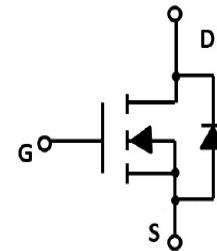
V <sub>DS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
20V	18mΩ@4.5V	6A
	22mΩ@2.5V	

## Application

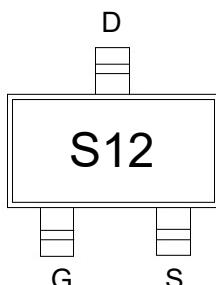
- PWM application
- Load switch



SOT-23 top view



Schematic diagram



S12: Device code

Marking and pin assignment



Halogen-Free

## Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Symbol	Parameter	Rating	Unit
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## Common Ratings (TC=25°C Unless Otherwise Noted)

V <sub>DS</sub>	Drain-Source Breakdown Voltage	20	V
V <sub>GS</sub>	Gate-Source Voltage	±10	V
T <sub>J</sub>	Maximum Junction Temperature	150	°C
T <sub>STG</sub>	Storage Temperature Range	-50 to 155	°C
I <sub>S</sub>	Diode Continuous Forward Current	Tc=25°C 6	A

## Mounted on Large Heat Sink

I <sub>DM</sub>	Pulse Drain Current Tested	Tc=25°C 25	A
I <sub>D</sub>	Continuous Drain Current	Tc=25°C 6	A
P <sub>D</sub>	Maximum Power Dissipation	Tc=25°C 1.25	W
R <sub>θJA</sub>	Thermal Resistance Junction-to-Ambient	100	°C/W

## Ordering Information (Example)

Type	Package	Marking	Minimum Package(pcs)	Inner Box Quantity(pcs)	Outer Carton Quantity(pcs)	Delivery Mode
MLS2312	SOT-23	S12	3,000	45,000	180,000	7"reel

Electrical Characteristics (TJ=25°C unless otherwise noted)						
Symbol	Parameter	Condition	Min	Typ	Max	Unit
<b>Static Electrical Characteristics @ TJ = 25°C (unless otherwise stated)</b>						
BV <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	20	--	--	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =20V, V <sub>GS</sub> =0V	--	--	1	μA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> =±10V, V <sub>DS</sub> =0V	--	--	±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	0.45	0.7	1.0	V
R <sub>DS(on)</sub>	Drain-Source On-State Resistance	V <sub>GS</sub> =4.5V, I <sub>D</sub> =5.0A	--	15	18	mΩ
		V <sub>GS</sub> =2.5V, I <sub>D</sub> =4.7A	--	19	22	mΩ
		V <sub>GS</sub> =1.8V, I <sub>D</sub> =4.3A	--	34	41	mΩ
<b>Dynamic Electrical Characteristics @ TJ = 25°C (unless otherwise stated)</b>						
C <sub>ISS</sub>	Input Capacitance	V <sub>DS</sub> =10V, V <sub>GS</sub> =0V, f=1MHz	--	885	--	pF
C <sub>OSS</sub>	Output Capacitance		--	135	--	pF
C <sub>RSS</sub>	Reverse Transfer Capacitance		--	120	--	pF
<b>Switching Characteristics</b>						
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> =10V, I <sub>b</sub> =6A, V <sub>GS</sub> =4.5V	--	11	--	nC
Q <sub>gs</sub>	Gate Source Charge		--	1.75	--	nC
Q <sub>gd</sub>	Gate Drain Charge		--	3	--	nC
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>DD</sub> =10V, R <sub>L</sub> =1.5Ω, V <sub>GS</sub> =4.5V, R <sub>G</sub> =3Ω	--	7	--	nS
t <sub>r</sub>	Turn-on Rise Time		--	45	--	nS
t <sub>d(off)</sub>	Turn-Off Delay Time		--	30	--	nS
t <sub>f</sub>	Turn-Off Fall Time		--	50	--	nS
<b>Source- Drain Diode Characteristics</b>						
V <sub>SD</sub>	Forward on voltage	T <sub>j</sub> =25°C, I <sub>s</sub> =6A	--	--	1.2	V

### Typical Operating Characteristics

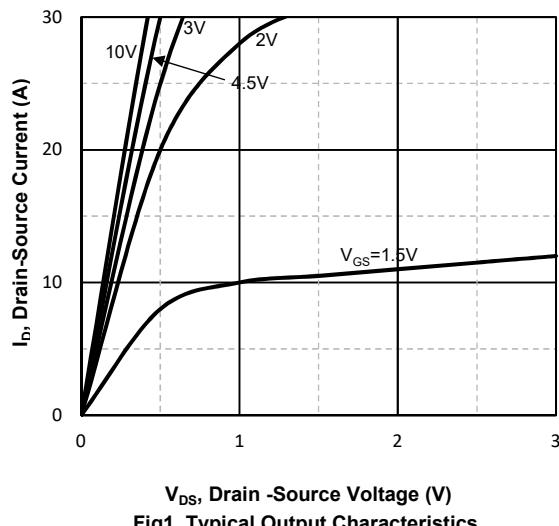


Fig1. Typical Output Characteristics

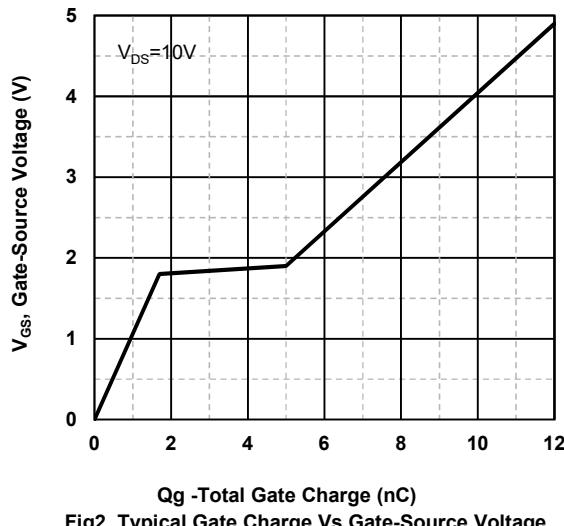


Fig2. Typical Gate Charge Vs. Gate-Source Voltage

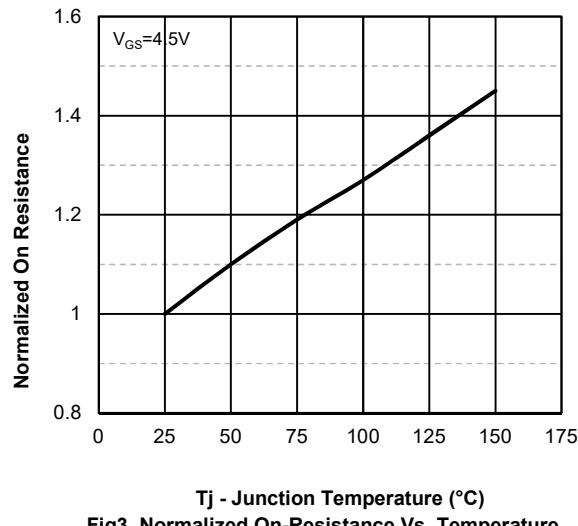


Fig3. Normalized On-Resistance Vs. Temperature

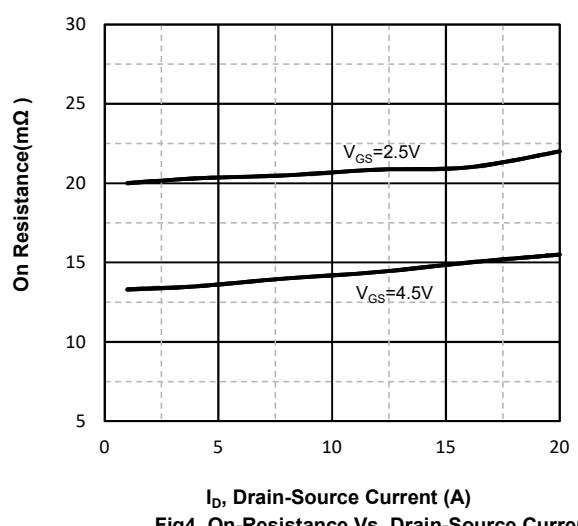


Fig4. On-Resistance Vs. Drain-Source Current

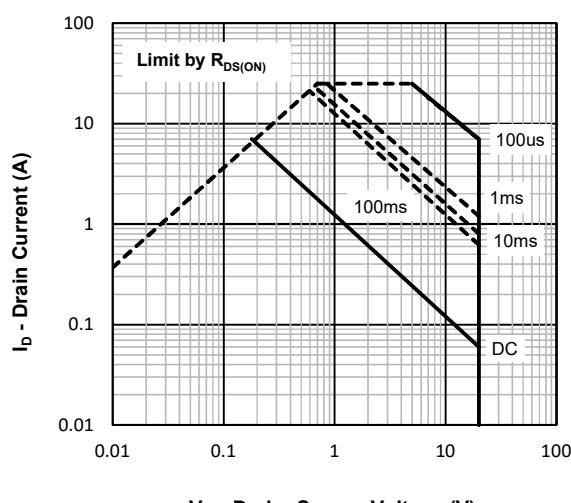


Fig5. Maximum Safe Operating Area

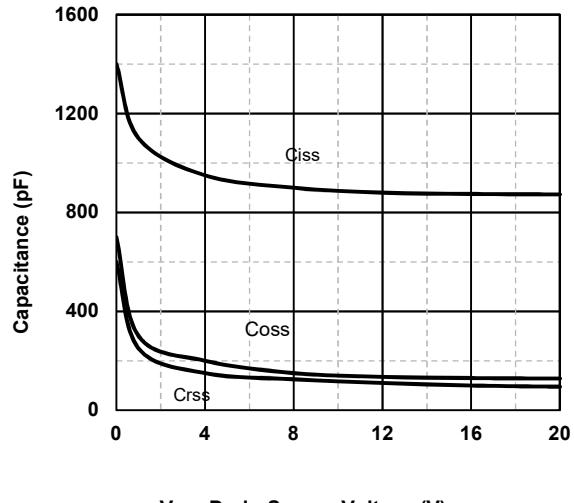
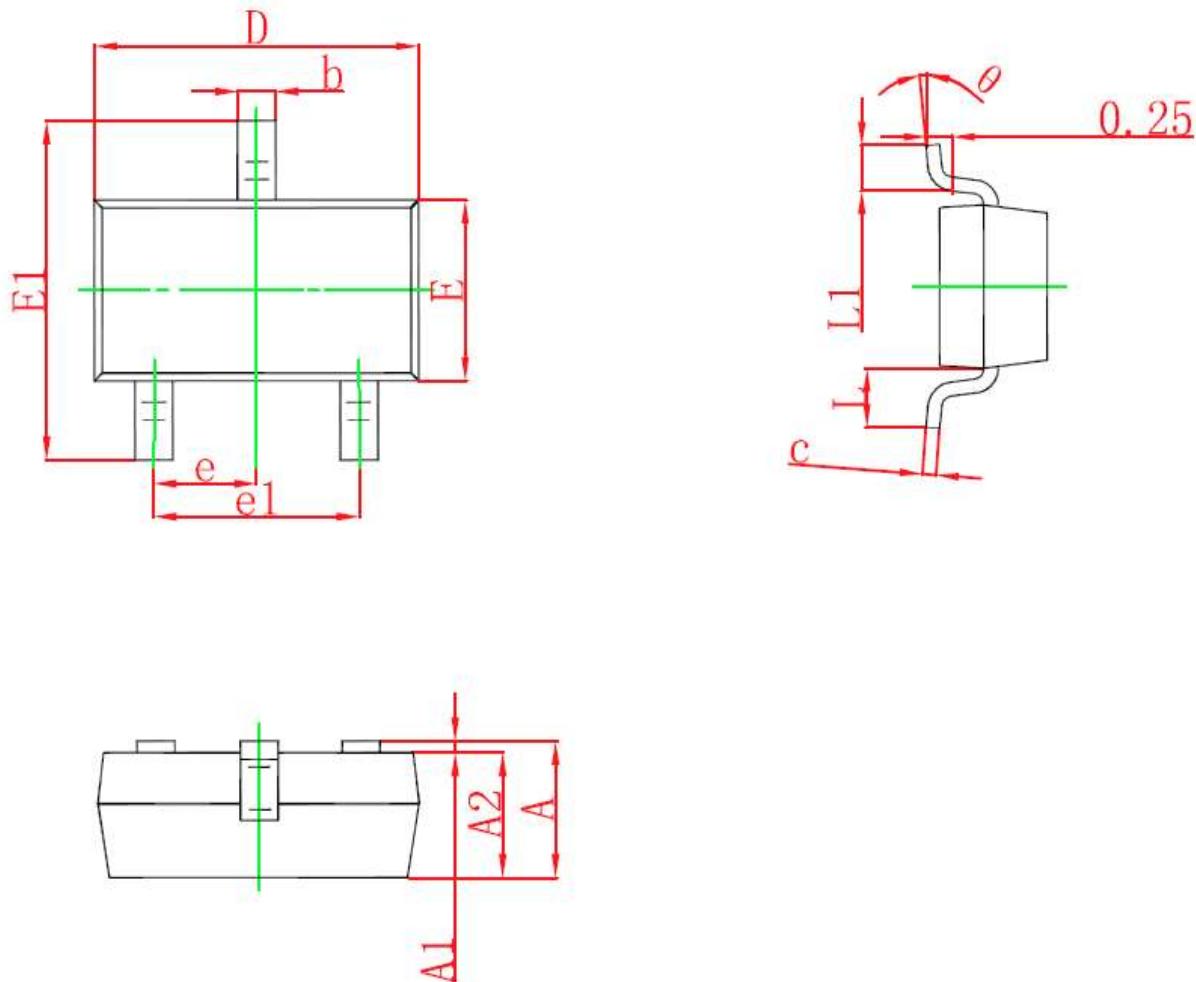


Fig6. Typical Capacitance Vs. Drain-Source Voltage

**SOT-23 Package information**


Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.550REF		0.022REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°